# **WITICK** Multilayer Ceramic Chip Capacitors CGA9P1X7T2J474M250KE

#### TDK item description CGA9P1X7T2J474MT\*\*\*S

Applications	Automotive Grade	42
Feature	AEC-Q200 AEC-Q200 Mid Mid Voltage (100 to 630V) Soft Soft Termination	T
Series	CGA9(5750) [EIA 2220]	B G
Status	Production	

Size		
Length(L)	5.70mm +0.50,-0.40mm	
Width(W)	5.00mm ±0.40mm	
Thickness(T)	2.50mm ±0.30mm	
Terminal Width(B)	0.20mm Min.	
Terminal Spacing(G)		
Recommended Land Pattern (PA)	4.10mm to 4.80mm	
Recommended Land Pattern (PB)	1.20mm to 1.40mm	
Recommended Land Pattern (PC)	4.00mm to 5.00mm	

Electrical Characteristics		
Capacitance	470nF ±20%	
Rated Voltage	630VDC	
Temperature Characteristic	X7T(+22,-33%)	
Dissipation Factor (Max.)	2.5%	
Insulation Resistance (Min.)	1063MΩ	

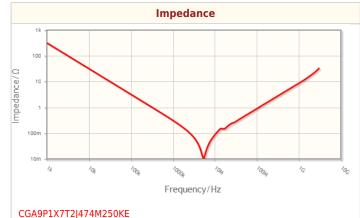
Other	
Soldering Method	Reflow
AEC-Q200	YES
Packing	Embossed (Plastic)Taping [180mm Reel]
Package Quantity	500pcs

! Images are for reference only and show exemplary products.

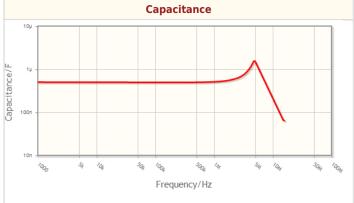
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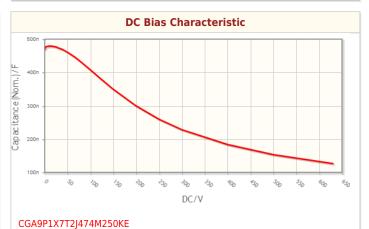
! All specifications are subject to change without notice.

## Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)



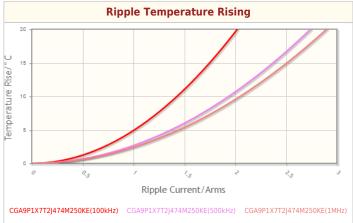






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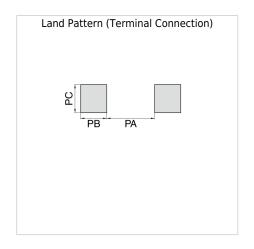
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RoHS Reach Halogen Free Pb Free

# Associated Images



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